

# EP1345HSTS-1.8432M

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## REGULATORY COMPLIANCE (Data Sheet downloaded on Oct 10, 2017)



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## ITEM DESCRIPTION

Quartz Crystal Clock Oscillators XO (SPXO) LVCMOS (CMOS) 3.3Vdc 8 Pin DIP Metal Thru-Hole 1.8432MHz ±50ppm -20°C to +70°C

## ELECTRICAL SPECIFICATIONS

|                                   |                                                                                                                                                                                                                                  |
|-----------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Nominal Frequency                 | 1.8432MHz                                                                                                                                                                                                                        |
| Frequency Tolerance/Stability     | ±50ppm Maximum (Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, First Year Aging at 25°C, Shock, and Vibration) |
| Aging at 25°C                     | ±5ppm/year Maximum                                                                                                                                                                                                               |
| Operating Temperature Range       | -20°C to +70°C                                                                                                                                                                                                                   |
| Supply Voltage                    | 3.3Vdc ±10%                                                                                                                                                                                                                      |
| Input Current                     | 28mA Maximum (Unloaded)                                                                                                                                                                                                          |
| Output Voltage Logic High (Voh)   | Vdd-0.4Vdc Minimum (IOH = -8mA)                                                                                                                                                                                                  |
| Output Voltage Logic Low (Vol)    | 0.4Vdc Maximum (IOL = +8mA)                                                                                                                                                                                                      |
| Rise/Fall Time                    | 4nSec Maximum (Measured at 20% to 80% of waveform)                                                                                                                                                                               |
| Duty Cycle                        | 50 ±10(%) (Measured at 50% of waveform)                                                                                                                                                                                          |
| Load Drive Capability             | 30pF Maximum                                                                                                                                                                                                                     |
| Output Logic Type                 | CMOS                                                                                                                                                                                                                             |
| Pin 1 Connection                  | Tri-State (Disabled Output: High Impedance)                                                                                                                                                                                      |
| Pin 1 Input Voltage (Vih and Vil) | 70% of Vdd Minimum to enable output, 20% of Vdd Maximum to disable output, No Connect to enable output.                                                                                                                          |
| Disable Current                   | 16mA Maximum (Pin 1 = Ground)                                                                                                                                                                                                    |
| Standby Current                   | 20µA Maximum (Pin 1 = Ground)                                                                                                                                                                                                    |
| Peak to Peak Jitter (tPK)         | 500pSec Maximum, 100pSec Typical                                                                                                                                                                                                 |
| RMS Period Jitter (tRMS)          | 50pSec Maximum, 15pSec Typical                                                                                                                                                                                                   |
| Start Up Time                     | 10mSec Maximum                                                                                                                                                                                                                   |
| Storage Temperature Range         | -55°C to +125°C                                                                                                                                                                                                                  |

## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

|                              |                                       |
|------------------------------|---------------------------------------|
| Fine Leak Test               | MIL-STD-883, Method 1014, Condition A |
| Gross Leak Test              | MIL-STD-883, Method 1014, Condition C |
| Lead Integrity               | MIL-STD-883, Method 2004              |
| Mechanical Shock             | MIL-STD-202, Method 213, Condition C  |
| Resistance to Soldering Heat | MIL-STD-202, Method 210               |
| Resistance to Solvents       | MIL-STD-202, Method 215               |
| Solderability                | MIL-STD-883, Method 2003              |
| Temperature Cycling          | MIL-STD-883, Method 1010              |
| Vibration                    | MIL-STD-883, Method 2007, Condition A |

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MECHANICAL DIMENSIONS (all dimensions in millimeters)



| PIN | CONNECTION                 |
|-----|----------------------------|
| 1   | Tri-State (High Impedance) |
| 4   | Case/Ground                |
| 5   | Output                     |
| 8   | Supply Voltage             |

| LINE | MARKING                                                                                    |
|------|--------------------------------------------------------------------------------------------|
| 1    | ECLIPTEK                                                                                   |
| 2    | EP13TS<br>EP13=Product Series                                                              |
| 3    | 1.8432M                                                                                    |
| 4    | XXYZZ<br>XX=Ecliptek Manufacturing Code<br>Y=Last Digit of the Year<br>ZZ=Week of the Year |

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OUTPUT WAVEFORM & TIMING DIAGRAM



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## Test Circuit for CMOS Output



Note 1: An external  $0.1\mu\text{F}$  low frequency tantalum bypass capacitor in parallel with a  $0.01\mu\text{F}$  high frequency ceramic bypass capacitor close to the package ground and  $V_{DD}$  pin is required.

Note 2: A low capacitance ( $<12\text{pF}$ ), 10X attenuation factor, high impedance ( $>10\text{Mohms}$ ), and high bandwidth ( $>300\text{MHz}$ ) passive probe is recommended.

Note 3: Capacitance value  $C_L$  includes sum of all probe and fixture capacitance.

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Recommended Solder Reflow Methods



High Temperature Solder Bath (Wave Solder)

|                                     |                                      |
|-------------------------------------|--------------------------------------|
| TS MAX to TL (Ramp-up Rate)         | 3°C/Second Maximum                   |
| Preheat                             |                                      |
| - Temperature Minimum (TS MIN)      | 150°C                                |
| - Temperature Typical (TS TYP)      | 175°C                                |
| - Temperature Maximum (TS MAX)      | 200°C                                |
| - Time (ts MIN)                     | 60 - 180 Seconds                     |
| Ramp-up Rate (TL to TP)             | 3°C/Second Maximum                   |
| Time Maintained Above:              |                                      |
| - Temperature (TL)                  | 217°C                                |
| - Time (tL)                         | 60 - 150 Seconds                     |
| Peak Temperature (TP)               | 260°C Maximum for 10 Seconds Maximum |
| Target Peak Temperature (TP Target) | 250°C +0/-5°C                        |
| Time within 5°C of actual peak (tP) | 20 - 40 Seconds                      |
| Ramp-down Rate                      | 6°C/Second Maximum                   |
| Time 25°C to Peak Temperature (t)   | 8 Minutes Maximum                    |
| Moisture Sensitivity Level          | Level 1                              |

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Recommended Solder Reflow Methods



Low Temperature Infrared/Convection 185°C

|                                     |                            |
|-------------------------------------|----------------------------|
| TS MAX to TL (Ramp-up Rate)         | 5°C/Second Maximum         |
| Preheat                             |                            |
| - Temperature Minimum (TS MIN)      | N/A                        |
| - Temperature Typical (TS TYP)      | 150°C                      |
| - Temperature Maximum (TS MAX)      | N/A                        |
| - Time (ts MIN)                     | 60 - 120 Seconds           |
| Ramp-up Rate (TL to TP)             | 5°C/Second Maximum         |
| Time Maintained Above:              |                            |
| - Temperature (TL)                  | 150°C                      |
| - Time (tL)                         | 200 Seconds Maximum        |
| Peak Temperature (TP)               | 185°C Maximum              |
| Target Peak Temperature (TP Target) | 185°C Maximum 2 Times      |
| Time within 5°C of actual peak (tP) | 10 Seconds Maximum 2 Times |
| Ramp-down Rate                      | 5°C/Second Maximum         |
| Time 25°C to Peak Temperature (t)   | N/A                        |
| Moisture Sensitivity Level          | Level 1                    |

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Recommended Solder Reflow Methods



Low Temperature Solder Bath (Wave Solder)

|                                     |                                                       |
|-------------------------------------|-------------------------------------------------------|
| TS MAX to TL (Ramp-up Rate)         | 5°C/Second Maximum                                    |
| Preheat                             |                                                       |
| - Temperature Minimum (TS MIN)      | N/A                                                   |
| - Temperature Typical (TS TYP)      | 150°C                                                 |
| - Temperature Maximum (TS MAX)      | N/A                                                   |
| - Time (ts MIN)                     | 30 - 60 Seconds                                       |
| Ramp-up Rate (TL to TP)             | 5°C/Second Maximum                                    |
| Time Maintained Above:              |                                                       |
| - Temperature (TL)                  | 150°C                                                 |
| - Time (tL)                         | 200 Seconds Maximum                                   |
| Peak Temperature (TP)               | 245°C Maximum                                         |
| Target Peak Temperature (TP Target) | 245°C Maximum 1 Time / 235°C Maximum 2 Times          |
| Time within 5°C of actual peak (tP) | 5 Seconds Maximum 1 Time / 15 Seconds Maximum 2 Times |
| Ramp-down Rate                      | 5°C/Second Maximum                                    |
| Time 25°C to Peak Temperature (t)   | N/A                                                   |
| Moisture Sensitivity Level          | Level 1                                               |

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum.

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum.